MXG X-Series Signal Generators N5181B Analog & N5182B Vector

9 kHz to 3 or 6 GHz 9 kHz to 7.2 GHz¹

Витали не сог 1000 стране корт. Солов стране корт. Солов стране корт. Солов стране корт. Солово стране корт. Солов стране	MXG	7 8 9 4 5 6 1 2 3 0 - - Mose Reture 63	Local California California Sature Sature California Califor	More de la construir de la con	LUGRY FIGHT
		 			
6.000 000 000 exc -20.00 etc news	MXG	7 8 9 4 5 6 1 2 3 0 - - Mon Rom 33	Local Pro- ling of the second	Manua Maria	Ever Note Parts Usager Parts Usager Parts Usager Parts Discont Store A Mathematical A Ma

1. Only applicable to N5182B + N5182BX07 Frequency Extender



DATA SHFFT

Table of Contents

Definitions and conditions	2
Frequency specifications	
Amplitude specifications	5
Spectral purity specifications	10
Analog modulation specifications	13
Vector modulation specifications-N5182B only	18
General specifications	
Inputs and outputs	
Related literature	

Pure and precise

On the path to better performance, the Keysight Technologies, Inc. MXG X-Series signal generators are fine-tuned to be your "golden transmitter" in R&D. Whether you're pushing for a linear RF chain or an optimized link budget, the analog and vector MXG models deliver what you need: phase noise, ACPR, channel coding, and more. Take your devices and designs to the limit with the MXG.

Definitions and Conditions

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ) describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 25 °C). Typical performance does not include measurement uncertainty.

Nominal (nom) values indicate the expected mean or average performance, or an attribute whose performance is by design, such as the 50 ohm connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas) describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Frequency Specifications

Option 503	9 kHz (5 MHz I/Q mode) to 3 GHz		
Option 506	9 kHz (5 MHz I/Q mode) to 6 GH	lz	
Option 506 + FRQ	9kHz (5 MHz I/Q mode) to 7.2 G	Hz ¹	
0.001 Hz			
Adjustable in nominal 0.1° in	crements		
Band	Frequency range	Ν	
1	9 kHz to < 5 MHz	1 (digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	
	Option 506 Option 506 + FRQ 0.001 Hz Adjustable in nominal 0.1° in Band 1 2 3 4 5	Option 506 9 kHz (5 MHz I/Q mode) to 6 GH Option 506 + FRQ 9kHz (5 MHz I/Q mode) to 7.2 G 0.001 Hz	

1. Only applicable to N5182B. Require option 506 and N5182BX07 Frequency Extender

2. N is a factor used to help define certain specifications within the document.

Frequency switching speed ^{1,2}				
	Standard	Option UNZ ³	Option UNZ, typical	
CW mode				
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs	
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs	
Digital modulation on (N5182	B only)			
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 1.05 ms	
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs	

1. Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater.

With internal channel corrections on, the frequency switching speed is < 1.3 ms, measured for list mode and SCPI mode cached frequency points. For the
initial frequency point in SCPI mode the time is < 3.3 ms, measured. The instrument will automatically cache the most recently used 1024 frequencies. There
is no speed degradation for amplitude-only changes.

 Specifications apply when status register updates are off. For export control purposes CW switching speed to within 0.05% of final frequency is 190 μs (measured).

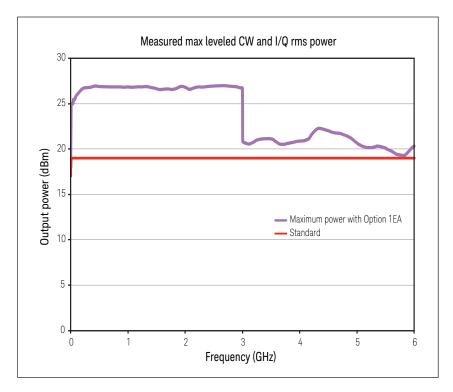
Frequency reference	
Accuracy	± (time since last adjustment x aging rate) ± temperature effects ± line voltage effects ± calibration accuracy
Internal time base reference oscillator aging rate ¹	< ± 1 x 10 ⁻⁷ /year < ± 5 x 10 ⁻¹⁰ /day after 30 days
Initial achievable calibration accuracy	± 4 x 10 ⁻⁸ or ± 40 ppb
Adjustment resolution	< 1 x 10 ⁻¹⁰
Temperature effects	< ± 2 x 10 ⁻¹⁰ , nominal
Line voltage effects	< ± 1 x 10 ⁻⁹ for ± 10% change, nominal
Reference output	
Frequency	10 MHz
Amplitude	\geq +4 dBm, nominal into 50 Ω load
External reference input	
Input frequency, standard	10 MHz
Input frequency, Option 1ER	1 to 50 MHz (in multiples of 0.1 Hz) ²
Stability	Follows the stability of external reference input signal
Lock range	±1 ppm
Amplitude	–3 dBm to +20 dBm, nominal
Impedance	50 Ω, nominal
Waveform	Sine or square
Sweep modes (frequency and amplitude)	
Operating modes	Step sweep (equally spaced frequency and amplitude or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency and amplitude steps) Simultaneously sweep waveforms with N5182B; see Baseband Generator section for more detail
Sweep range	Within instrument frequency range
Dwell time	100 µs to 100 s
Number of points	2 to 65535 (step sweep) 1 to 3201 (list sweep)
Step change	Linear or logarithmic
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

Not verified by Keysight N7800A TME Calibration and Adjustments Software. Daily aging rate may be verified as a supplementary chargeable service, on request.
 Close-in phase noise will degrade when reference input is tuned away from 10 MHz.

Amplitude Specifications

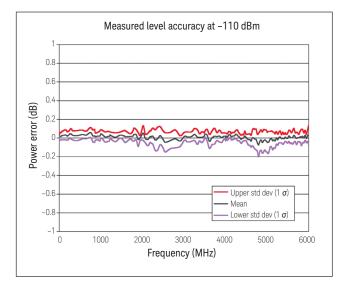
Output parameters				
Settable range		+19 to -144 dBm (Standard) +30 to -144 dBm (Option 1EA)		
Resolution	0.01 dB			
Step attenuator	0 to 130 dB in 5 dB step	0 to 130 dB in 5 dB steps electronic type		
Connector	Type N 50 Ω, nominal	Type N 50 Ω, nominal		
Max output power ¹ () = typica	al			
Frequency	Standard	Option 1EA		
9 kHz to 10 MHz	+13 dBm	+17 dBm (+18 dBm)		
> 10 MHz to 3 GHz	+18 dBm	+24 dBm (+26 dBm)		
> 3 to 5 GHz	+16 dBm	+19 dBm (+20 dBm)		
> 5 to 6.0 GHz	+16 dBm	+18 dBm (+19 dBm)		

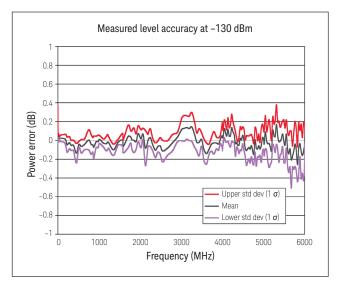
1. Quoted specifications between 20 °C and 30 °C. Maximum output power typically decreases by 0.01 dB/°C for temperatures outside this range.

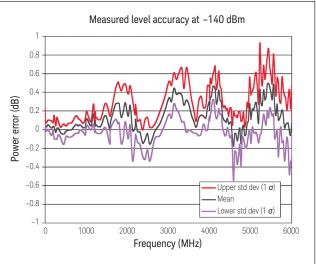


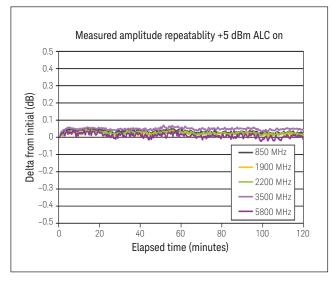
Absolute level accuracy in CW mode ¹ (ALC on) ()= typical				
	Standard		Option 1EQ	
Range	Max power to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm	
9 to 100 kHz	(± 0.6 dB)	(± 0.9 dB)		
100 kHz to 5 MHz	± 0.8 dB (± 0.3)	± 0.9 dB (± 0.3)		
> 5 MHz to 3 GHz	± 0.6 dB (± 0.3)	± 0.8 dB (± 0.3)	± 1.5 dB (± 0.5)	
> 3 to 6 GHz	± 0.6 dB (± 0.3)	± 1.1 dB (± 0.3)	± 1.6 dB (± 0.6)	
Absolute level accuracy in CW mode (ALC off, power search run, relative to ALC on)				
9 kHz to 6 GHz	± 0.15 dB, typical			
Absolute level accuracy in digital I/Q mode (N5182B only)				
(ALC on, relative to CW, W-CDMA 1 DPCH configuration < +10 dBm)				
5 MHz to 6 GHz	± 0.25 dB, (0.05 dB)			

1. Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/°C. Output power may drift up to 0.10 dB < 3 GHz and 0.15 dB > 3 GHz per g/kg change in absolute humidity (nom).

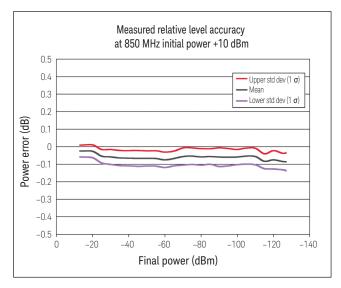




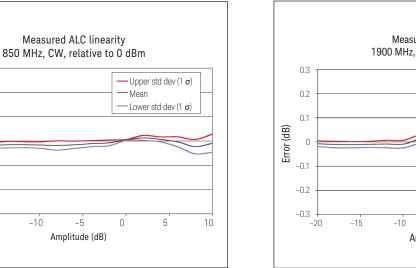


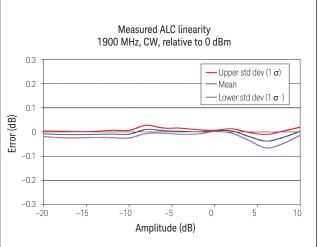


Repeatability measures the ability of the instrument to return to a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.



Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (such as 5 dB steps).





0.3

0.2

0.1

-0.1

-0.2

-0.3

-20

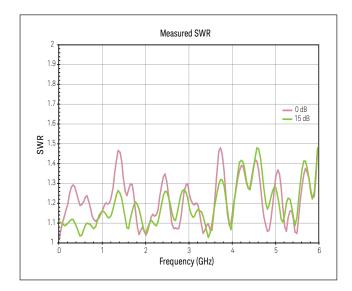
-15

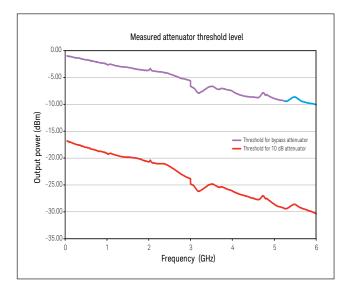
0

Error (dB)

SWR (measured CW mod	e) ¹		
Frequency	Attenuator state		
	Bypass	0 to 10 dB	15 dB or more
≤ 1.0 GHz	< 1.3:1	< 1.35:1	< 1.2:1
> 1.0 to 2 GHz	< 1.55:1	< 1:5:1	< 1.3:1
> 2 to 3 GHz	< 1.8:1	< 1.5:1	< 1.45:1
> 3 to 4 GHz	< 1.5:1	< 1.6:1	< 1.7:1
> 4 to 6 GHz	< 1.9:1	< 1.6:1	< 1.6:1

1. SWR < 1.60:1 below 30 kHz.





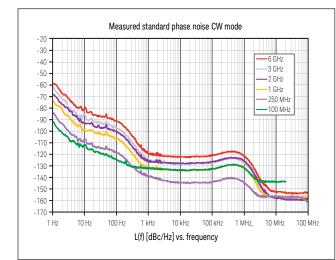
Maximum reverse power, nominal			
< 1 GHz	50 W		
> 1 to 2 GHz	25 W		
> 2 to 6 GHz	20 W		
Max DC voltage	50 VDC		
Trip level	2 W		
Amplitude switching speed ¹	Standard	Option UNZ	Option UNZ, typical
CW mode			
SCPI mode	≤ 5 ms, typical	≤ 750 μs	≤ 650 µs
Power search SCPI mode	< 12 ms, measured		
List/step sweep mode	≤ 5 ms, typical	≤ 500 μs	≤ 300 µs
Digital modulation on (N5182B only)			
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs
Power search SCPI mode	< 12 ms, measured		
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 400 μs
Alternate power level control (N5182	2B only)		
Switching time (via waveform markers)	20 μs within ± 1 dB, measure	ed	
Functional power range	–15 dBm to –144 dBm, meas	sured	
User flatness correction			
Number of points	3201		
Number of tables	Dependent on available free memory in instrument; 10,000 maximum		
Entry modes	USB/LAN direct power mete meter control	r control, LAN to GPIB and USB to (GPIB, remote bus and manual USB/GPIB power
Sweep modes			
	See Frequency Specification	s section for more detail	

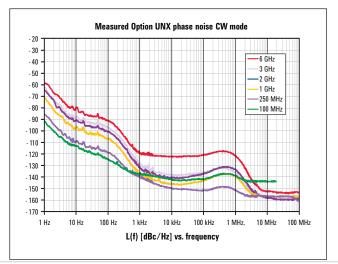
1. Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. Switching speed specifications apply when status register updates are off.

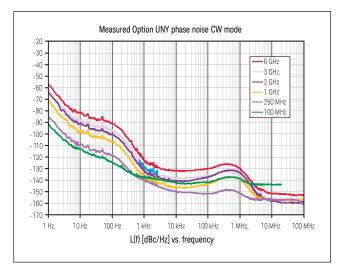
Spectral Purity Specifications

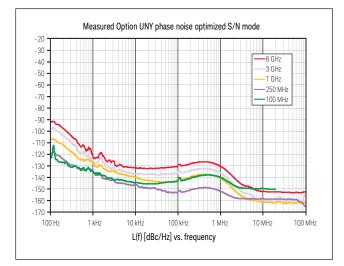
Standard abso	lute SSB phase n	oise (dBc/Hz, CW, at 2	0 kHz offset) () = typi	cal ¹		
5 MHz to < 250) MHz		-129 (-133)			
250 MHz			-140 (-143)			
500 MHz			-135 (-139)			
1 GHz			-131 (-134)			
2 GHz			-124 (-127)			
3 GHz			-123 (-127)			
4 GHz			-118 (-122)			
6 GHz			-116 (-121)			
Option UNX ab	solute SSB phase	e noise (dBc/Hz, CW, a	t 20 kHz offset) () = ty	pical 1		
5 MHz to < 250) MHz		-140 (-143)			
250 MHz			-144 (-150)			
500 MHz			-143 (-150)			
1 GHz			-141 (-146)			
2 GHz			-135 (-141)			
3 GHz			-131 (-137)			
4 GHz			-118 (-122)			
6 GHz			-117 (-121)			
Option UNY ab	solute SSB phase	e noise (CW) () = meas	ured ¹			
Frequency	1 Hz	10 Hz	100 Hz	1 kHz	10 kHz	100 kHz
100 MHz	(-91)	(–113)	(–124)	(–137)	(-142)	(-142)
249 MHz	(-85)	-93 (-110)	-103 (-118)	-130 (-137)	-139 (-142)	-138 (-142)
250 MHz	(-85)	-96 (-110)	-104 (-118)	-127 (-139)	-144 (-150)	-147 (-152)
500 MHz	(-74)	-89 (-100)	-98 (-109)	-125 (-139)	-139 (-149)	-145 (-149)
1 GHz	(-70)	-87 (-97)	-93 (-106)	-123 (-136)	-141 (-146)	-140 (-143)
2 GHz	(-65)	-79 (-90)	-85 (-101)	-114 (-131)	-135 (-140)	-134 (-137)
3 GHz	(-61)	-74 (-88)	-81 (-98)	-112 (-128)	-132 (-138)	-131 (-135)
4 GHz	(-61)	-73 (-84)	-79 (-95)	-110 (-124)	-130 (-134)	–127 (–131)
6 GHz	(-57)	-69 (-81)	-76 (-91)	-107 (-121)	-126 (-132)	–125 (–129)

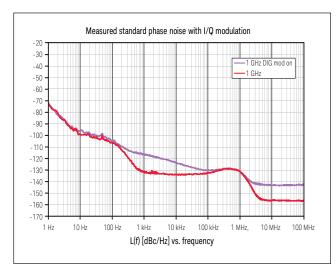
1. From 20 to 30 °C, excludes mechanic vibration, measured @ +10 dBm or maximum specified power, whichever is less.

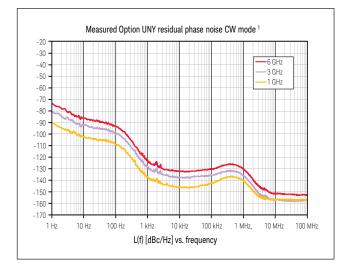


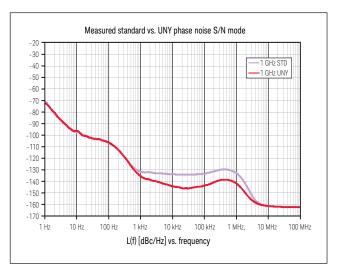


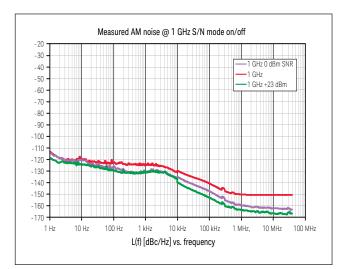












1. Use external 10 MHz input path, between +3 to +7 dBm for maximum performance.

5 MHz to 6 GHz	< N x 2 Hz (measured) (se	e N value in frequency ba	and table)		
Residual AM (CW mode, 0.3 to 3 l	kHz BW, rms, +5 dBm)				
100 kHz to 3 GHz	< 0.01% (measured)				
Harmonics (CW mode)					
Range	Standard < +4 dBm		Option 1EA < +12 dBm		
9 kHz to 3 GHz	< -35 dBc		< -30 dBc		
> 3 to 4 GHz	< -35 dBc, typical		< –35 dBc, typical		
> 4 to 6 GHz	< -53 dBc, typical		< -40 dBc, typical		
Nonharmonics (CW mode) ^{1} () = t	ypical				
Range	> 10 KHz offset				
	Standard (dBc)		UNX or UNY (dBc)		
9 kHz to < 5 MHz	–65, nominal		–65, nominal		
5 to < 250 MHz	-75		-75 (-80)		
250 to < 750 MHz	-87		-96 (-100)		
750 MHz to < 1.5 GHz	-87		-92 (-96)		
1.5 to < 3.0 GHz	-81		-86 (-90)		
3 to 6 GHz	-75		-80 (-84)		
Subharmonics (CW mode) () = ty	pical				
Hz to 1.5 GHz	None				
> 1.5 to 3 GHz	–77 dBc (–91)				
> 3 to 6 GHz	-74 dBc (-81)				
Jitter (standard phase noise) ²					
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, typical	Seconds, typical	
155 MHz	155 MB/s	100 Hz to 1.5 MHz	91.8	0.6 ps	
622 MHz	622 MB/s	1 KHz to 5 MHz	50.5	81 fs	
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	198	80 fs	
Jitter (UNX or UNY phase noise) ²					
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, measured	Seconds, measured	
155 MHz	155 MB/s	100 Hz to 1.5 MHz	40	0.25 ps	
622 MHz	622 MB/s	1 KHz to 5 MHz	21	33 fs	
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	72	29 fs	
Phase coherence (Option 012)					
LO input frequency range	250 MHz to 6 GHz, nomir	nal			
LO input power range	0 to +12 dBm, nominal				
LO output frequency range	250 MHz to 6 GHz, nomir	nal			
LO output power range	0 to +12 dBm, nominal				

< 3 GHz fixed 100 MHz spur is specified @ -78 dBc. In signal-to-noise optimization mode 100 MHz spur is < -100 dBc, measured.
 Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

Analog Modulation Specifications

Frequency bands			
Band #	Frequency range	N	
1	9 kHz to < 5 MHz	(digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	
Frequency modulation (Option UNT) (S	ee N value above)		
Max deviation	N × 4 MHz, nominal ³		
Resolution	1 Hz, nominal		
Deviation accuracy	< ± 2% + 20 Hz (1 kHz rate, deviation is N	x 50 kHz)	
Modulation frequency response	1 dB bandwidth	DC/5 Hz to 3 MHz, nominal	
@ 100 kHz deviation	3 dB bandwidth	DC/1 Hz to 7 MHz, nominal	
Carrier frequency accuracy	$<\pm$ 0.2% of set deviation + (N \times 1 Hz) $^{\rm 1}$		
Relative to CW	$<\pm$ 0.06% of set deviation + (N \times 1 Hz), ty	pical ²	
Total harmonic distortion	< 0.4% [1 kHz rate, deviation is N x 50 kHz	z]	
FM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω/600 Ω/1 MΩ, nominal	
	Paths	FM path 1 and FM path 2 are summed internally for composite modulation	
Phase modulation (Option UNT) (See N	value above)		
Maximum deviation	Normal bandwidth	N × 2 radians, nominal	
	High-bandwidth mode	N × 0.2 radians, nominal	
Frequency response	Normal bandwidth (3 dB)	DC to 1 MHz, nominal	
	High-bandwidth mode (3 dB)	DC to 4 MHz, nominal	
Resolution	0.1% of deviation		
Deviation accuracy	< + 0.5% + 0.01 rad, typical [1 kHz rate, n	ormal bandwidth mode]	
Total harmonic distortion	< 0.2%, typical [1 kHz rate, N x 1 radian deviation normal bandwidth mode]		
Φ M using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω or 600 Ω or 1 M Ω , nominal	
	Paths	Φ M path 1 and Φ M path 2 are summed internally for composite modulation	

Specification valid for temperature changes of less than ± 5 °C since last DCFM calibration.
 Typical performance immediately after a DCFM calibration.
 Digital synthesis band FM deviation is 5 MHz.

Amplitude modulation (Option UN	Г) ¹						
AM depth type	Linear or exponer	itial					
Maximum depth	100%						
Depth resolution	0.1% of depth (nom)						
AM depth error	f < 5 MHz		< 1.5% of set	ting + 1% (typ 0.5%	of setting + 1%)		
@1 KHz rate and < 80% depth	5 MHz < f < 2 GHz	< 2 GHz < 3% of setting + 1 %					
	2 < f < 3 GHz		< 5% of setting + 1% (typical 3% of setting + 1%)				
Total harmonic distortion			30% depth	< 0.25%, typi	cal		
@ 1 KHz rate	F < 5 MHz		80% depth	< 0.5%, typic	al		
	5 MHz < f < 2 GHz (2 to 3 GHz is typ		30% depth 80% depth	< 2% < 2%			
Frequency response	30% depth, 3 dB	BW	DC/10 Hz to	50 KHz			
Frequency response wideband AM (N5182B only)	Rates ALC off/on: DC/800 Hz to 80 MHz, nominal						
AM inputs using external inputs 1 or 2	Sensitivity		± 1 V peak fo 2.2 V peak)	or indicated depth(C	Over-range can be 2009	6 or	
	Input impedance		50 Ω or 600	50Ω or 600Ω or 1M $\Omega,$ Damage level: ± 5 V max			
	Paths		AM path 1 and AM path 2 are summed internally for composite modulation				
Wideband AM inputs (N5182B only)	Sensitivity		1 V peak-to- 100% AM	peak sine wave signa	al with 0.5 V DC offset r	equired input for	
	Input impedance 50 Ω, nominal (I input)						
Simultaneous and composite mod	ulation ²						
Simultaneous modulation	modulation canno modulation sourc	ot be combined e; for example,	and two modulation	types cannot be sin enerator, AM, and FN	multaneously enabled e nultaneously generated A can run concurrently	using the same	
Composite modulation	AM, FM, and Φ M each consist of two modulation paths which are summed internally for composite modulation; modulation can be any combination of internal or external sources			ite modulation;			
	AM	FM	Phase	Pulse	Internal I/Q ¹	External I/Q ¹	
AM	+	+	+	+	+	+	
FM	+	+	-	+	+	+	
Phase	+	-	+	+	+	+	
Pulse	+	+	+	-	+	+	
Internal I/Q (1)	+	+	+	+	-	+	
External I/Q (1)	+	+	+	+	+	_	
+ = compatible, - = incompatible, *	= Internal + Externa	l					

AM specifications apply 6 dB below maximum specified power from 20 to 30 °C.
 I/Q modulation available on N5182B.

External modulation inputs	
(Option UNT required for FM, AM, and phase modu	Ilation inputs; Option UNW required for pulse modulation inputs)
EXT1	AM, FM, PM
EXT2	AM, FM, PM
PULSE	Pulse (50 Ω only)
	Wideband AM (50 Ω only, N5182B only requires Q to be biased with 1.0 V)
Input impedance	50 Ω, 1 MΩ, 600 Ω, DC and AC coupled
Standard internal analog modulation source	
(Single sine wave generator for use with AM, FM,	phase modulation requires Option UNT or 303)
Waveform	Sine, square, triangle, positive ramp, negative ramp
Rate range	0.1 Hz to 2 MHz (tunable to 3 MHz)
Resolution	0.1 Hz
Frequency accuracy	Same as RF reference source, nominal
LF audio output	O to 5 V peak into 50 $\Omega,$ –5V to 5 V offset, nominal
Multifunction generator (Option 303)	
The multifunction generator option (Option 303) c ously using the composite modulation features in	onsists of seven waveform generators that can be set independently with up to five simultane- AM. FM/PM. and LF out
Waveform	
Function generator 1	Sine, triangle, square, positive ramp, negative ramp, pulse
Function generator 2	Sine, triangle, square, positive ramp, negative ramp, pulse
Dual function generator	Sine, triangle, square, positive ramp, negative ramp, phase offset, and amplitude ratio for Tone 2 relative to Tone 1
Swept function generator	Sine, triangle, square, positive ramp, negative ramp Trigger: free run, trigger key, bus, external, internal, timer trigger
Noise generator 1	Uniform, Gaussian
Noise generator 2	Uniform, Gaussian
DC	Only for LF output –5 V to +5 V, nominal
Frequency parameters	
Sine wave	0.1 Hz to 10 MHz
Triangle, square, ramp, pulse	0.1 Hz to 1 MHz, nominal
Noise bandwidth	10 MHz, nominal
Resolution	0.1 Hz
Frequency accuracy	Same as RF reference source, nominal
Narrow pulse modulation (Option UNW) ¹ () = typica	ıl
On/off ratio	(> 80 dB)
Rise/fall times (Tr, Tf)	< 10 ns; (7 ns)
Minimum pulse width ALC on/off	> 2 µs/> 20 ns
Repetition frequency ALC on/off	10 Hz to 500 kHz/DC to 10 MHz
Level accuracy (relative to CW) ALC on/off ²	< ± 1.0 (± 0.5) dB/(< ± 0.5) dB
Width compression (RF width relative to video out)	(< 5 ns)

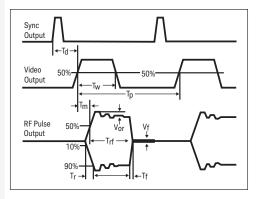
Pulse specifications apply to frequencies > 100 MHz and power set to > -3 dBm. Operable down to 9 kHz.
 With power search on.

Video feed-through $^1 \leq 3$ GHz/> 3 GHz	(< 50 mV/< 5mV)
External video delay (ext input to video)	30 ns, nominal
RF delay (video to RF output)	20 ns, nominal
Pulse overshoot	(< 15%)
Input level	+1 Vpeak = RF on into 50 Ω, nominal

T_d video delay (variable)

T_w video pulse width (variable)

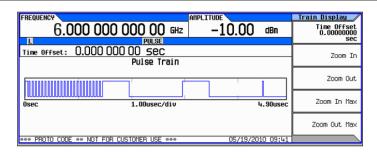
- T_p pulse period (variable)
- T_m RF delay
- T_{rf} RF pulse width
- T_f RF pulse fall time
- T_r RF pulse rise time
- V_{or} pulse overshoot
- V_f Video feedthrough



Internal pulse generator (included with O	ption UNW)			
Modes	Free-run, square, tri	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse		
Square wave rate	0.1 Hz to 10 MHz, 0.1	Hz resolution, nominal		
Pulse period	30 ns to 42 seconds,	nominal		
Pulse width	20 ns to pulse period	I –10 ns, nominal		
Resolution	10 ns			
Adjustable trigger delay	(– pulse period + 10	(– pulse period + 10 ns) to (pulse width –10 ns)		
Settable delay	Free run	-3.99 to 3.97 μs		
	Triggered	0 to 40 s		
Resolution (delay, width, period)	10 ns, nominal			
Pulse doublets	1st pulse delay	(Relative to sync out) 0 to 42 s – pulse width – 10 ns		
	1st pulse width	500 ns to 42 s – delay – 10 ns		
	2nd pulse delay	0 to 42 s – (Delay 1 + Width 2) – 10 ns		
	2nd pulse width	20 ns to 42 s – (Delay 1 + Delay 2) – 10 ns		

Pulse train generator Option 320 (requires Option UNW)

Number of pulse patterns	2047
On/off time range	20 ns to 42 sec



1. Video feed through applies to power levels < +10 dBm.

Avionics		
VOR (Option 302)		
Bearing accuracy		± 0.1 degrees
Frequency accuracy		Same as RF reference source, nominal
AM accuracy	30% depth	± 5% of setting
AM distortion		2%
FM accuracy	480 Hz deviation	± 1.7 Hz
ILS: localizer and glide slope (Option 302)		
AM accuracy	40% depth	± 5% of setting
AM distortion		2%
Difference in depth of modulation (DDM)	Localizer	0.0002
resolution	Glide slope	0.0004
Difference in depth of modulation (DDM)	Localizer	$\pm 0.0004 \pm 5\%$ of DDM ¹
accuracy	Glide slope	$\pm \ 0.0008 \pm 5\% \ of \ DDM^{1}$
Marker beacon (Option 302)		
Marker tone AM accuracy	95% depth	± 5% of setting + 1%
Marker tone AM distortion	95% depth	5%

1. DDM must not be equal to 0.

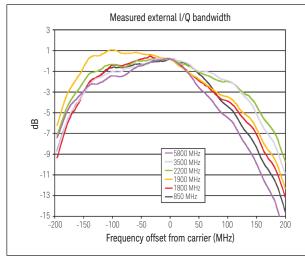
Vector Modulation Specifications

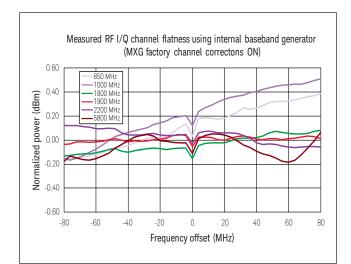
N5182B only

I/Q modulator external inputs ¹			
Bandwidth	Baseband (I or Q) RF (I+Q)	Up to 100 MHz baseband, nominal Up to 200 MHz RF, nominal	
l or Q offset	± 100 mV (200 uV resoluti	on)	
I/Q gain balance	± 4 dB (0.001 dB resolutio	n)	
I/Q attenuation	0 to 50 dB (0.01 dB resolu	tion)	
Quadrature angle adjustment	± 200 units (0.1 units reso	lution)	
Full scale input drive (I+Q)	0.5 V into 50Ω , nominal		
Internal I/Q baseband generator adju	stments ^{1,2} (Options 656 and 657)		
I/Q offset	± 20% (0.025% resolution)		
I/Q gain	± 1 dB (0.001 dB resolutio	n)	
Quadrature angle adjustment	± 10 ° (0.01 degrees resolu	ution)	
I/Q phase	± 360.00 ° (0.01 degrees r	esolution)	
I/Q skew	± 800.00 ns (1 picosecond resolution)		
I/Q delay	± 250.00 ns (1 picosecond resolution)		
External I/Q outputs ¹			
Impedance	50 Ω , nominal per output		
	100 Ω , nominal differentia	loutput	
Туре	Single-ended or differential (Option 1EL)		
Maximum voltage per output	1 V peak-to-peak or 0.5 V peak		
Bandwidth (I, Q)	Baseband (I or Q)	80 MHz, nominal (Option 656 and 657)	
	RF (I+Q)	160 MHz, nominal (Option 656 and 657)	
Amplitude flatness	± 0.2 dB measured with channel corrections optimized for I/Q output		
Phase flatness	± 2.5 degrees measured with channel corrections optimized for I/Q output		
Common mode I/Q offset	\pm 1.5 V into 50 Ω (200 μ V resolution)		
Differential mode I or Q offset	\pm 50 mV into 50 Ω (200 μ V resolution)		

I/Q adjustments represent user intverface nominal parameter ranges and not specifications. Internal I/Q adjustments apply to RF out and I/Q outputs simultaneously. 1.

2.





Internal real-time complex digital I/Q filters (included with Option 656)

Factory channel correction (256 taps)

Corrects the linear phase and amplitude response of the baseband I/Q and RF outputs of the signal generator using factory calibration arrays. (default mode is off)

RF amplitude flatness (160 MHz)	± 0.2 dB measured
RF phase flatness (160 MHz)	± 2 degrees measured
User channel correction (256 taps)	
Automated routine uses power sensor to corr	ect for linear phase and amplitude response of DUT (equalizer). See Users Guide for more details.
Recommended max amplitude error for correction	± 15 dB
Recommended max phase error for	± 25 degrees
correction	
Equalization filter (256 tanc)	

Equalization filter (256 taps)

User can download and apply inverse or custom phase and amplitude response coefficients from tools such as MATLAB, 89600 VSA or SystemVue to correct for linear errors of DUT/system. See Users Guide for more details.

Baseband generator (Options 656 and 657)		
Channels	2 [I and Q]	
Resolution	16 bits [1/65,536]	
Sample rate	Option 656 Option 656 and 657	100 Sa/s to 100 MSa/s 100 Sa/s to 200 MSa/s
Maximum number of waveform files in cache	1024	
RF (I+Q) bandwidth	Option 656 Option 656 and 657	80 MHz, nominal 160 MHz, nominal
Interpolated DAC rate	800 MHz (waveforms only need OSR =	1.25)
Frequency offset range	± 80 MHz	
Digital sweep modes	In list sweep mode each point in the list can have independent waveforms (N5182B) along with user definable frequencies and amplitudes; see the Amplitude and Frequency Specifications sections for more detail.	
Waveform switching speed ¹		≤ 5 ms, measured (standard)
	SCPI mode	≤ 1.2 ms, measured (Option UNZ)
	List/step sweep mode	≤ 5 ms, measured (standard)
		\leq 900 µs, measured (Option UNZ)
Waveform transfer rates	FTP LAN to internal SSD	10.7 MB/sec or 2.67 Msa/sec
(measured, no markers, unencrypted)	Internal SSD to FTP LAN	7.7 MB/sec 1.92 Msa/sec
	FTP LAN to BBG	8.2 MB/sec or 2.05 Msa/sec
	FTP LAN to BBG encrypted	4 MB/sec or 1 Msa/sec
	USB to BBG	19 MB/sec or 4.75 Msa/sec
	BBG to USB	1.2 MB/sec or 300 Ksa/sec
	Internal SSD to BBG	48 MB/sec or 12 Msa/sec
	BBG to internal SSD	1.2 MB/sec or 300 Ksa/sec
	SD card to BBG (Option 006)	2.7 MB/sec or 678 Ksa/sec
	BBG to SD card (Option 006)	845 KB/sec or 211 Ksa/sec

1. SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate \ge 10 MSa/s.

Maximum playback 2: Maximum playback 2: Maximum playback Maximum storage 3: Bytes RO biol 02:0 Maximum storage 3: Bytes RO biol 02:0 markers 3: Bytes RO biol 02:0 Waveform segments 5: Bytes RO biol 02:0 Maximum segments 5: Bytes RO biol 02:0 Segment length 5: Bytes RO biol 00:0 Maximum memory al- tocacion per segment 5: Samples to 5:12 Mas (Option 00:2) Maximum number of segments 5: Samples to 5:12 Mas (Option 00:2) Maximum number of segments 8: Bit22 Label Maximum number of segments/sequence Maximum number of segments/sequence 3: 20:00 (standard) Segment sequences 3: 20:00 (standard) Maximum number of repetitions 2: 20:00 (standard) Segment sequences 5: 5: 5: 5: 5: 5: 5: 5: 5: 5: 5: 5: 5: 5	Arbitrary waveform memory		32 Msa (standard)		
cigacity 1024 Msa (Option 023) Maximum storage apacity including markers 3 GBytes/7.5 Gsa (Option 000) Waveform segments 8 GBytes / 2 Gsa (Option 000) Minimum memory al- location per segment 60 samples to 512 Msa (Option 023) Minimum memory al- location per segment 256 samples Maximum number of segments 8 192 Label Maximum number of waveform sequences Maximum number of segments 2000 depending on non-volatile memory usage sequences Waveform sequences Maximum number of sequences Maximum number of repetitions 2000 depending on non-volatile memory usage sequences Trigger sequences 30.000 (standard) Maximum number of repetitions 4 million (Option 022 or 023) Maximum number of repetitions 30.000 (standard) Surce Trigger key, external, bus (GPIB, LAN, USB) Carite Segment davance Single Note cortinuous, single, gated, segment advance Single rotaris (Biger only) 35 ns to 40 s Trigger latency (Single trigger only) 35 ns to 40 s Single rotaris (Biger only) 35 ns to 40 s Single rotarestalay resolution		Maximum playback		2)	
Maximum storage capacity including markers 3 GBytes/800 Msa (standard) Waveform segments Segment length 60 samples to 512 Msa (Option 009) Minimum memory al- location per segment 60 samples to 512 Msa (Option 022) 60 samples to 1024 Msa (Option 023) Minimum memory al- location per segment 256 samples 60 samples to 1024 Msa (Option 023) Maximum number of segments 8192 5000 depending on non-volatile memory usage Sequences Maximum number of sequences 2000 depending on non-volatile memory usage Maximum number of repetitions 2000 depending on non-volatile memory usage Triggers Maximum number of repetitions 2000 (standard) Maximum number of repetitions 50srce Trigger key, external, bus (OPIB, LAN, USB) Triggers Source Trigger acturacy (Single trigger only) 35 fins + 1 sample clock period, nominal Trigger acturacy (Single trigger only) 35 fins + 1 sample clock period, nominal Trigger latency (Single trigger only) 35 fins + 1 sample clock period, nominal Multi-baseband generator synchromize tin mode (multiple sources) Fin out 1 master and up to 15 slaves Trigger latency Sample repetition Single trigger or speriod + 1 master and up to 15 sl		capacity			
Image: instruction of the second se					
Image: Continuous single, part of the source of t					
Waveform segments Segment length 60 samples to 512 Mas (dpoint 00.0) Waveform segments Aminimum memory al- location per segment 256 samples Value 1024 256 samples Value 1024 Waveform sequences Maximum number of segments 8192 Value 1024 Waveform sequences Maximum number of sequences >2000 depending on non-volatile memory usage Sequences Maximum number of sequences >2000 (standard) Maximum number of repetitions 32,000 (standard) Segment Sequence 4 million (Option 022 or 023) Maximum number of repetitions 50 core Trigger s Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Cartinuous Free run, trigger and run, reset and run Single No retrigger, buffered trigger, restart on trigger Gated Nodes Single ro ontinuous External coarse delay resolution 5 ns Trigger latency (Single trigger only) 256 ns + 1 sample clock period, nominal Trigger latency (Single trigger only) 25 ns, nominal			· · · · ·		
Segment length 60 samples to 512 Msa (Option 022) 60 samples to 1024 Msa (Option 023) Minimum memory al location per segment 266 samples Maximum number of segments 8192 segments Label Maximum number of value Value 1024 Waveform sequences Maximum number of sequences Maximum number of repetitions >2000 depending on non-volatile memory usage sequences Maximum number of repetitions >2000 depending on non-volatile memory usage sequences Trigger s Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Continuous Single No retrigger, buffered trigger, restart on trigger Segment advance Single Single No retrigger, buffered trigger, restart on trigger Segment advance Single Single ro continuous Single ro continuous External coarse delay time 5 ns to 40 s External coarse delay time 5 ns to 40 s External coarse delay tigger rom/y 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) 356 ns + 1 sample clock p	Mousform comments				
Multi-baseband generator synchronization 60 samples to 1024 Msa (Option 023) Minimum memory al- location per segment 256 samples Maximum number of segments 8192 Label Maximum number of waveform files Value 1024 Waveform sequences Maximum number of segments Maximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequence 32,000 (standard) Segments/sequence 4 million (Option 022 or 023) Maximum number of repetitions 65,535 Trigger s Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, nestart on trigger Modes Single no retrigger, upsertive polarity or positive polarity Single trigger only 3 5 ns Trigger latency (Single trigger only) 3 2.00 seminal Single trigger only 3 2.5 ns, nominal Multi-baseband generator synchronization 5 ns Itrigger repeatability < 1 ns, nominal	waverorm segments	Comment langth	· · ·		
Minimum memory al- location per segment 256 samples Maximum number of segments 8192 Label Maximum number of Value 8192 Waveform sequences Maximum number of segments/sequences 2000 depending on non-volatile memory usage sequences Maximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequence 32,000 (standard) Maximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequences 32,000 (standard) Moximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequences 32,000 (standard) Maximum number of segments/sequences 32,000 (standard) Segment advance 5,535 Trigger securacy Gontinuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Continuous Free run, trigger and run, reset and run Sigle No retriger, buffred trigger, restart on trigger Segment advance Sigle retrigger only Segment advance Sigle or continuous External coarse delay resolution		Segment length	· · · · · · · · · · · · · · · · · · ·		
Ideation per segment Maximum number of segments 8192 Label Maximum number of waveform files Value 1024 Waveform sequences Maximum number of sequences > 2000 depending on non-volatile memory usage sequences Maximum number of repetitions > 2000 (standard) Trigger s Maximum number of repetitions > 2000 (standard) Trigger s Trigger key, external, bus (GPIB, LAN, USB) Maximum number of repetitions Single No retrigger, buffered trigger, restart on trigger Trigger s Trigger key, external, bus (GPIB, LAN, USB) Single Mades Single No retrigger, buffered trigger, restart on trigger External coarse delay time 5 ns to 40 s Single reger retriger retriger retriger Trigger accuracy (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) Multi-baseband generator synchronizat Trigger reteat on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) + 1 sample clock period, nominal Multi-baseband generator synchronizat Trigger repeatability < 1 ns, nominal			· · · · · · · · · · · · · · · · · · ·	Msa (Option 023)	
Maximum number of segments 8192. Label Maximum number of value 1024 Waveform sequences Maximum number of sequences >2000 depending on non-volatile memory usage sequences Maximum number of repetitions 32,000 (standard) Maximum number of repetitions 32,000 (standard) Triggers Maximum number of repetitions 65,535 Trigger s Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, nestart on trigger Gated Negative polarity or positive polarity Segment advance Single No retrigger, centinuous External coarse delay resolution 5 ns 5 ns to 40 s External coarse delay resolution 5 ns 1 Single trigger only) ±2.5 ns, nominal 1 Trigger latency (Single trigger only) ±2.5 ns, nominal 1 Trigger repetability 1 nsater and up to 15 slaves 1 Trigger repetability 1 ns, nominal 1 Trigger repetability 1 ns, nominal 1			256 samples		
Label Maximum number of waveform files Value 1024 Waveform sequences Maximum number of sequences > 2000 depending on non-volatile memory usage sequences Maximum number of repetitions 32,000 (standard) - Triggers Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, buffered trigger, restart on trigger Modes Single No retrigger, buffered trigger, restart on trigger External coarse delay time 5 ns to 40 s Single trigger only) Single trigger only 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Mutti-baseband generator synchronization mode (muttiple sources) Fan out 1 master and up to 15 slaves finger repeatability < 1 ns, nominal		Maximum number of	8192		
Value 1024 Waveform sequences Maximum number of sequences > 2000 depending on non-volatile memory usage Maximum number of repetitions 32,000 (standard) Maximum number of repetitions 32,000 (standard) Triggers Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, outring rest and run Single No retrigger, outring rest and run Single Modes Single No retrigger, continuous Free run, trigger and run, reset and run Single No retrigger, buffered trigger, restart on trigger Gated Negative polarity or positive polarity Segment advance Single or continuous Single or continuous Single run External coarse delay trie 5 ns to 40 s Strigger advance Single run Trigger accuracy (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Mutti-baseband generator synchronization Fan out 1 master and up to 15 slaves Trigger repetability < 1 ns, nominal			Maximum number of	f waveform files	
sequences 32,000 (standard) waximum number of segments/sequence 32,000 (standard) Maximum number of repetitions 65,535 Triggers Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Medes Single No retrigger, buffered trigger, restart on trigger Gated Negative polarity or positive polarity Segment advance Single No retrigger, buffered trigger, restart on trigger External coarse delay time 5 ns to 40 s External coarse delay trigger only) 356 ns + 1 sample clock period, nominal Trigger latency (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger latency (Single trigger only) 4 segment advance Single trigger restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is supe period) Multi-baseband generator synchronizat tion mode (multiple sources) Fan out 1 master and up to 15 slaves Trigger repeatability < 1 ns, nominal					
segments/sequence 4 million (Option 022 or 023) Maximum number of repetitions 65,535 Triggers Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, outrigger, nestart on trigger Modes Single No retrigger, positive polarity or positive polarity External coarse delay time 5 ns to 40 s Second and and and and and and and and and a	Waveform sequences		> 2000 depending o	n non-volatile memory usage	
segments/sequence4 million (Option 022 or 023)Maximum number of repetitions65,535TriggersTypesContinuous, single, gated, segment advanceSourceTrigger key, external, bus (GPIB, LAN, USB)ModesSingleNo retrigger, nest and runSingleNo retrigger, path or reger and run, reset and runSingleNo retrigger, positive polarityGatedNegative polarity or positive polarityExternal coarse delay time5 ns to 40 sExternal coarse delay time5 ns to 40 sExternal coarse delay resolution5 nsTrigger accuracy (Single trigger only)356 ns + 1 sample clock period, nominalTrigger accuracy (Single trigger only)± 2.5 ns, nominalMulti-baseband generator synchronizationFan out1 master and up to 15 slavestion mode (multiple sources)Fan out1 master and up to 15 slavesTrigger accuracySame as normal modeTrigger accuracySame as normal modeFine trigger delay rangeSee Internal I/Q Baseband section		Maximum number of	32,000 (standard)		
riggersTypesContinuous, single, gated, segment advanceSourceTrigger key, external, bus (GPIB, LAN, USB)ModesSingleNo retrigger, and run, reset and runSingleNo retrigger, buffered trigger, restart on triggerGatedNegative polarity or positive polaritySegment advanceSingle or continuousExternal coarse delay time5 ns to 40 sExternal coarse delay resolution5 nsTrigger latency (Single trigger only)356 ns + 1 sample clock period, nominalTrigger accuracy (Single trigger only)± 2.5 ns, nominalSingle trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is µ s + (1406 x sample period) ± 1 sample clock period, nominalMulti-baseband generator synchronize tion mode (multiple sources)Fan out1 master and up to 15 slavesTrigger repeatability< 1 ns, nominal			4 million (Option 022	2 or 023)	
Triggers Types Continuous, single, gated, segment advance Source Trigger key, external, bus (GPIB, LAN, USB) Modes Single No retrigger, buffered trigger, restart on trigger Gated Negative polarity or positive polarity Segment advance Single or continuous External coarse delay time 5 ns to 40 s External coarse delay resolution 5 ns Trigger latency (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization Fan out 1 master and up to 15 slaves (multiple sources) Trigger repeatability < 1 ns, nominal			65,535		
Multi-baseband generator synchronization mode Fan out Trigger repeatability <1 master and up to 15 slaves	Triggers			Continuous, single, gated, segment advance	
Modes Single No retrigger, buffered trigger, restart on trigger Gated Negative polarity or positive polarity Segment advance Single or continuous External coarse delay time 5 ns to 40 s External coarse delay resolution 5 ns Trigger latency (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization mode Fan out 1 master and up to 15 slaves frigger accuracy Same as normal mode Trigger latency (multiple sources) Fine trigger delay range See Internal I/Q Baseband section				Trigger key, external, bus (GPIB, LAN, USB)	
Modes Gated Negative polarity or positive polarity Segment advance Single or continuous External coarse delay time 5 ns to 40 s External coarse delay resolution 5 ns Trigger latency (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization mode Fan out 1 master and up to 15 slaves Trigger accuracy Same as normal mode Trigger latency (multiple sources) Fine trigger delay range See Internal I/Q Baseband section			Continuous	Free run, trigger and run, reset and run	
Modes Gated Negative polarity or positive polarity Segment advance Single or continuous External coarse delay time 5 ns to 40 s External coarse delay resolution 5 ns Trigger latency (Single trigger only) 356 ns + 1 sample clock period, nominal Trigger accuracy (Single trigger only) ± 2.5 ns, nominal Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization mode Fan out 1 master and up to 15 slaves Trigger accuracy Same as normal mode Trigger latency (multiple sources) Fine trigger delay range See Internal I/Q Baseband section			Single	No retrigger, buffered trigger, restart on trigger	
External coarse delay time5 ns to 40 sExternal coarse delay resolution5 nsTrigger latency (Single trigger only)356 ns + 1 sample clock period, nominalTrigger accuracy (Single trigger only)± 2.5 ns, nominalSingle trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominalMulti-baseband generator synchronization mode (multiple sources)Fan out1 master and up to 15 slavesTrigger repeatability< 1 ns, nominal		Modes			
External coarse delay time5 ns to 40 sExternal coarse delay resolution5 nsTrigger latency (Single trigger only)356 ns + 1 sample clock period, nominalTrigger accuracy (Single trigger only)± 2.5 ns, nominalSingle trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominalMulti-baseband generator synchronization mode (multiple sources)Fan out1 master and up to 15 slavesTrigger repeatability< 1 ns, nominal			Segment advance	Single or continuous	
Trigger latency (Single trigger only)356 ns + 1 sample clock period, nominalTrigger accuracy (Single trigger only)± 2.5 ns, nominalSingle trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominalMulti-baseband generator synchroniza- tion mode (multiple sources)Fan outTrigger repeatability< 1 ns, nominal		External coarse delay t	time	*	
Image: construction of the construc		· · · · · · · · · · · · · · · · · · ·		5 ns	
Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization mode (multiple sources) Fan out 1 master and up to 15 slaves Trigger repeatability < 1 ns, nominal				356 ns + 1 sample clock period, nominal	
buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal Multi-baseband generator synchronization mode Fan out 1 master and up to 15 slaves (multiple sources) Trigger repeatability < 1 ns, nominal				± 2.5 ns, nominal	
tion mode Trigger repeatability <1 ns, nominal					
Inggenere additive Christian (multiple sources) Triggen accuracy Same as normal mode Triggen latency Same as normal mode Fine trigger delay range See Internal I/Q Baseband section	Multi-baseband generator synchroniza-				
Trigger latency Same as normal mode Fine trigger delay range See Internal I/Q Baseband section	tion mode			< 1 ns, nominal	
Fine trigger delay range See Internal I/Q Baseband section				Same as normal mode	
				Same as normal mode	
				See Internal I/Q Baseband section	
I/Q phase adjustment range See Internal I/Q Baseband section		I/Q phase adjustment i	range		

Markers	Markers are defined in a segment during the waveform generation process, or from the front panel; a marker can also be routed to the RF blanking, ALC hold functions, and alternate amplitude; see Users Guide for more information		
	Marker polarity	Negative, positive	
	Number of markers	4	
	RF blanking/burst on/off ratio	> 80 dB	
	Alternate amplitude control switching speed	See amplitude section	
Real-time modulation FIR filter:	Filter Types: Nyquist, root-Nyquist, WCDMA, EDGE, Gaussian, rectangular, APCO 25 C4FM, IS-95, User FIR (Applies real-time FIR filtering when playing waveforms with OSR=1. Helps reduce waveform size for long simulation times. Option 660 not required.)		
Real-time baseband generator (Optio	n 660)		
Real-time baseband generator required for real-time Signal Studio	Cellular real-time applications	LTE-FDD, LTE-TDD, HSPA+/W-CDMA, GSM/EDGE, cdma2000®	
applications ¹	Real-time navigation	GPS, GLONASS, Galileo	
	Real-time video applications	DVB-T/T2/H/S/S2/C/J.83 Annex A/C, ISDB-T/	
	Note: Option 660 is not required for real-time custom modulation (Option 431)		
	Memory: Shares memory with Options 656 and 657		
	Triggering: Same as Options 656 and 657		
	Markers: 3 markers available, all other features are same as Options 656 and 657		

Digital baseband inputs/outputs (Option 003/004)

Options 003 and 004 activate the rear panel digital I/Q bus and enable connectivity to the N5102A digital signal interface module. In output mode (003), you can deliver realistic complex-modulated signals such as LTE, GPS, WLAN, custom pulses and many others directly to your digital devices and subsystems. In the input mode (004), the interface module ports your digital input to the signal generator's baseband system, providing a quick and easy way of upconverting to calibrated analog I/Q, IF, or RF frequencies. In both operating modes, the interface module adapts to your device with the logic type, data format, clock features, and signaling you require.

Data (requires N5102A)	
Digital data format	User-selectable: 2's complement or binary offset, I/Q (I, I-bar, Q, Q-bar) or digital IF output (real, imaginary)
Data port	Dual 16-bit data buses support parallel, parallel I/Q interleaved, parallel Q/I interleaved, or serial port configuration
N5102A connectors (breakout boards)	144-pin Tyco Z-Dok+ connects to break-out boards (included with N5102A) that interface with the following connector types: 68-pin SCSI, 38-pin dual AMP Mictor, 100-pin dual Samtec, 20-pin dual 0.1 inch headers, 40-pin dual 0.1 inch headers
Logic types	Single-ended: LVTTL, 1.5V CMOS, 1.8V CMOS, 2.5V CMOS, 3.3.V CMOS
	Differential: LVDS
Data output resampling	MXG baseband output is resampled to the arbitrary clock rate set by the user via real-time curve-fit calculations.

1. See www.keysight.com/find/signalstudio for more information.

Clock (requires N5102A)					
Clock input	User selectable: internal clock, device under test clock, or external clock (via SMA or breakout board)				
	N5102A SMA Ext Clock In connector: 50 Ω, 0 dBm nominal, 1 to 400 MHz				
Clock output	User selectable: via breakout board or SMA Clock C				
	N5102A SMA Clock Out connector: 2 Vpp into load 100 kHz to 400 MHz	$> 5 K \ \Omega$ from 1 to 100 kHz, 400 mVpp into 50 Ω load from			
Sample rate (limited by MXG sample rate)	User-selectable in parallel mode up to a maximum 200 MHz, but limited by other user settings (see users guide for more details).				
	User-selectable in serial mode, the maximum rate is 400 MHz/word size.				
Bit rate (limited by MXG sample rate)	Parallel Up to 200 MHz x word size (1.6 Gbps LVDS, 2 parallel buses available	, CMOS and LVTTL) per parallel bus,			
	Serial Up to 400 MHz per serial line (400 Mbps LVD lines available	S) or 150 MHz per serial line (150 Mbps (CMOS/LVTTL) 32			
Clocks per sample	In parallel output mode, the data sample can be hel	ld for 1, 2 or 4 clock cycles			
Clock to data skew	Coarse adjustment in 90° steps from 0 to 270°; fine	-adjustment in increments of 100 ps up to 5 ns			
Clock polarity	Clock signals may be inverted				
Frequency reference input	1 to 100 MHz BNC, 50 Ω, 3 dBm ± 6 dB				
Power supply (included on N5102A)	Output: 5V, 4A DC				
AWGN (Option 403)					
Гуре	Real-time, continuously calculated, and played usin	ng DSP			
Modes of operation	Standalone or digitally added to signal played by ar				
Bandwidth	With Option 656	1 Hz to 80 MHz			
	With Option 656 and 657	1 Hz to 160 MHz			
Crest factor	15 dB				
Randomness	90 bit pseudo-random generation, repetition period 313 x 10 ⁹ years				
Carrier-to-noise ratio	\pm 100 dB when added to signal				
Carrier-to-noise ratio formats	C/N, Eb/No				
Carrier-to-noise ratio error	Magnitude error ≤ 0.2 dB at baseband I/Q outputs				
Custom modulation Arb Mode (Option					
Modulation	PSK	BPSK, QPSK, OQPSK, π/4DQPSK, gray coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK, IS95 QPSK, IS95 OQPSK, EDGE, HDQPSK			
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings			
	FSK	Selectable: 2,4,8, 16, C4FM, HCPM			
	MSK	0 to 100 °			
	ASK	0 to 100%			
	DVB-S2 APSK	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10			
Multicarrier	Number of carriers	Up to 100 (limited by a max bandwidth of 160 MHz depending on symbol rate and modulation type)			
	Frequency offset (per carrier)	Up to -80 to +80 MHz			
	Power offset (per carrier)	0 dB to -40 dB			
Symbol rate	50 sps to 100 Msps				
ilter types	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 C4FM, user	IS-95 w/EQ, IS-95 Mod, IS-95 Mod w/EQ, HDQPSK, APCO25 HCPM, SOQPSK-TG			
Quick setup modes	APCO 25w/C4FM, APCO25 w/CQPSK, <i>Bluetooth</i> [®] , CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10			
Data	Random only				

Custom modulation real-time	mode (Option 431) (Does not require C	ption 660)				
Modulation	PSK	PSK				
	QAM		4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)			
		Selectable	2,4,8, 16 level symmetric, C4FM			
	FSK	User-defined	Custom map of up to 16 deviation levels			
		Max deviation	20 MHz			
	MSK	0 to 100 °	·			
	ASK	0 to 100%				
	Custom I/Q	Custom map of 1024 unique values				
Frequency offset	Up to –80 MHz to +80 MHz					
Symbol rate	Internal generated data	1 sps up to 100 Msps and max o	f 10 bits per symbol (Option 656+ 657)			
	External serial data	1 sps to [(50 Mbits/sec)/(#bits/symbol)]				
Filter types	Selectable	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 (phase 1 and 2 UL and DL), IS-95, WCDMA,EDGE (wide and HSR)				
	Custom FIR	Custom FIR 16-bit resolution, up to 64 symbols lon coefficients (max) > 32 to 64 symbol filter: symbol rate ≤ > 16 to 32 symbol filter: symbol rate ≤ Internal filters switch to 16 tap when s				
Quick setup modes		K, HCPM, HDQPSK), TETRA , <i>Blueto</i> lium, ICO, CT2, TFTS, SOQPSK	oth, CDPD, DECT, EDGE, GSM, NADC, PDC,			
Trigger delay	Range		0 to 1,048,575 bits			
	Resolution		1 bit			
Data types		Pseudo-random patterns	PN9, PN11, PN15, PN20, PN23			
	Internally generated	Repeating sequence	Any 4-bit sequence			
			32 Mb (standard)			
	Direct-pattern RAM [PRAM] Note: Used for custom TDN		512 Mb (Option 022)			
	Note. Used for custom TDM	ia/non-stanuaru framiny	1024 Mb (Option 023)			
			32 MB (standard)			
	User file		512 MB (Option 022)			
			1024 MB (Option 023)			
	Externally streamed data	Туре	Serial data			
	(via AUX I/O)	Inputs/outputs	Data, symbol sync, bit clock			
Internal burst shape	Rise/fall time range	· ·	Up to 30 bits			
(varies with bit rate)	Rise/fall delay range					

Multitone and two-tone (Option 430)			
Number of tones	2 to 512, with selectable on	/off state per tone	
Frequency spacing	100 Hz to 160 MHz (Option	656 and 657)	
Phase (per tone)	Fixed or random		
Real-time phase noise impairments (Op	otion 432)		
Close-in phase noise characteristics	–20 dB per decade		
Far-out phase noise characteristics	–20 dB per decade		
Mid-frequency characteristics	Start frequency (f1)	Offset settable from 0 to 77 MHz	
	Stop frequency (f2)	Offset settable from 0 to 77 MHz	
Phase noise amplitude level (L(f))	User selected; max degrada	ition dependent on f2	



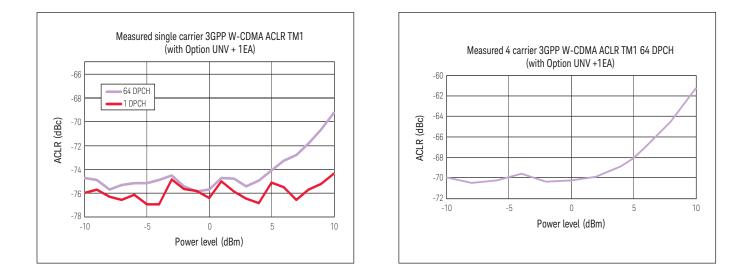
3GPP W-CDMA distortion performance ^{1,2}

			Standard		Option UN	1	Option UN with Option		
Power level			≤ 2 dBm ²		≤ 2 dB m ²	≤ 2 dBm ²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур	
Adjacent (5 MHz)	1 0001 1	1000 to 0000 MU	– 69 dBc	–73 dBc	–71 dBc	–75 dBc	–71 dBc	–75 dBc	
Alternate (10 MHz)	- 1 DPCH, 1 carrier	1800 to 2200 MHz	–70 dBc	–75 dBc	–72 dBc	–77 dBc	–71 dBc	–77 dBc	
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-68 dBc	–70 dBc	–71 dBc	–73 dBc	–71 dBc	–72 dBc	
Alternate (10 MHz)	64 DPCH, 1 carrier	1800 to 2200 MHz		–73 dBc	–72 dBc	–76 dBc	–71 dBc	–76 dBc	
Adjacent (5 MHz)	Test model 1 with	1000 to 2200 MUz	-63 dBc	-65 dBc	-65 dBc	-67 dBc	-64 dBc	-66 dBc	
Alternate (10 MHz)	64 DPCH, 4 carrier	1800 to 2200 MHz	-64 dBc	-66 dBc	-66 dBc	-68 dBc	-66 dBc	-68 dBc	

1.

2.

ACPR specifications apply when the instrument is maintained within 20 to 30 °C. This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5dB = +16.5 dBm PEP).



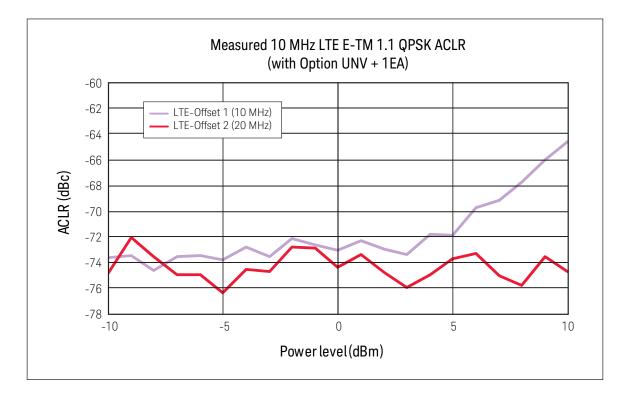
3GPP LTE-FDD distortion performance ¹								
			Standard		Option UN\	/	Option UN with Option	
Power level			≤ 2 dB m ²		≤ 2 dBm ²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (10 MHz) ³	10 MHz E-TM 1.1	1800 to 2200 MHz	–64 dBc	-66 dBc	-67 dBc	-69 dBc	-64 dBc	-67 dBc
Alternate (20 MHz) ³	QPSK	1800 to 2200 MHz	-66 dBc	-68 dBc	-69 dBc	–71 dBc	-69 dBc	–71 dBc

ACPR specifications apply when the instrument is maintained within 20 to 30 °C. 1.

2.

This is rms power. Convert from rms to peak envelope power with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).

ACPR measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration bandwidth: 9.015 MHz. 3.



GSM/EDGE output I	RF spectrum (ORFS)					
			GSM		EDGE	
Power level			< +7 dBm		< +7 dBm	
Offset	Configuration	Frequency ¹	Standard, typical	Option UNV, typical	Standard, typical	Option UNV, typical
200 kHz			-34 dBc	–36 dBc	–37 dBc	-38 dBc
400 kHz	4 1.1 1.1	800 to 900 MHz	-69 dBc	–70 dBc	-69 dBc	–70 dBc
600 kHz	1 normal timeslot, – bursted	800 to 900 MHz 1800 to 1900 MHz	-81 dBc	-82 dBc	-80 dBc	-81 dBc
800 kHz	burðteu		-82 dBc	-83 dBc	-82 dBc	-83 dBc
1200 kHz	-		-84 dBc	–85 dBc	-83 dBc	-84 dBc
3GPP2 cdma2000 d	listortion performance	e, typical				·
			Standard	Option UNV	Option UNV + 1EA	
Power level ²			<mark>≤ 2dB</mark> m	≤ 2 dBm	<mark>≤ 5 dB</mark> m	
Offset	Configuration	Frequency (1)	Typical	Typical	Typical	
885 kHz to 1.98 MHz			–78 dBc	–79 dBc	–77 dBc	
> 1.98 to 4.0 MHz	9 channel forward link	800 to 900 MHz	-86 dBc	–87 dBc	-87 dBc	
> 4.0 to 10 MHz			-91dBc	–93 dBc	–93 dBc	
802.16e Mobile WiMA	X™ distortion performa	nce, measured				
Power	Offset ³	Configuration ⁴	Frequency	Standard, measured	UNV, measured	
< -7 dBm	10 MHz	QPSK	2.5 and 3.5 GHz	–65 dBc	–68 dBc	
Up to +5 dBm	10 MHz	QPSK	3.5 GHz	-62 dBc	-65 dBc	

 Performance evaluated at bottom, middle, and top of bands shown.
 This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example: 3GPP test model 1 with 64 DPCH has a crest factor > 11 dB, therefore at +5 dBm rms the PEP = 5 dBm + 11 dB = +16 dBm PEP).
 Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz.
 802.16e WiMAX signal configuration-bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/8, symbol rolloff: 5%, content: 30 symbols of PN9 determined. data.

EVM performance	data ^{1,2}									
Format	GSM		EDGE		cdma200	0/IS95A	W-CDMA		LTE FDD ³	
Modulation type	GMSK (burs	ted)	3pi/8 8PSI	3pi/8 8PSK (bursted)		QPSK		QPSK		
Modulation rate	270.833 ksp	os	70.833 ksp)S	1.2288 M	cps	3.84 Mcp	S	10 MHz BV	V
Configuration	1 timeslot		1 timeslot		Pilot char	าทยไ	1 DPCH		E-TM 3.1	
Frequency ⁴	800 to 900 1800 to1900		800 to 900 1800 to 19		800 to 90	0 MHz 900 MHz	1800 to 2	200 MHz	1800 to 22	00 MHz
EVM power level	≤ 7 dBm		≤7 dBm		≤7 dBm		≤7 dBm		≤ 7 dBm	
EVM power level with Option 1EA	≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm	
EVM/global phase error	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур	Measured	
	rms 0.8 °	0.2 °	1.2%	0.75%	1.3%	0.8%	1.2%	0.8%	0.2%	
Format	802.11a/g	802.11ac 5	QPSK				16 QAM			
Modulation type	64 QAM	256 QAM	QPSK				16 QAM			
Modulation rate	54 Mbps	80 MHz	4 Msps (ro	ot-Nyquist filt	er α = 0.25)					
Frequency ⁴	2400 to 2484 MHz	5.775 GHz	≤ 3 GHz		≤ 6 GHz		≤ 3 GHz		≤ 6 GHz	
	5150 to 5825 MHz		2.5 GHZ				2 3 0 12		20002	
EVM power level	≤ –5 dBm	≤ –5 dBm	≤4 dBm		≤ 4 dBm		≤ 4 dBm		≤ 4 dBm	
EVM power level with Option 1EA	≤ 2 dBm	≤2 dBm	≤ 10 dBm		≤ 10 dBm		≤ 10 dBm		≤ 10 dBm	
EVM	Measured	Measured	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур
	0.3%	0.4%	1.2%	0.8%	1.9%	1.1%	1.1%	0.65%	1.5%	0.9%

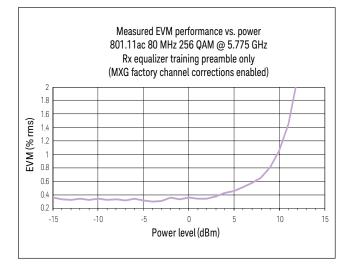
1.

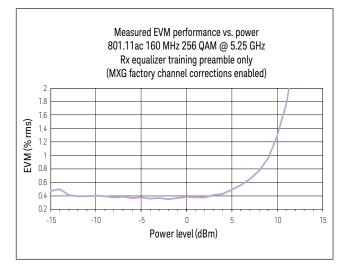
EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument. EVM specifications apply after execution of I/Q calibration when the instrument is maintained within ± 5 °C of the calibration temperature. 2.

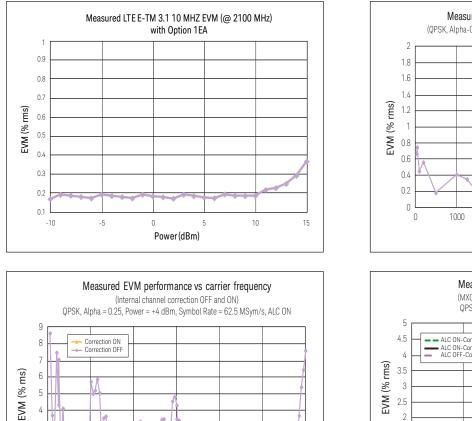
3. LTE FDD E-TM 3.1,10 MHz, 64 QAM PDSCH, full resource block. Measured EVM after DC calibration.

4.

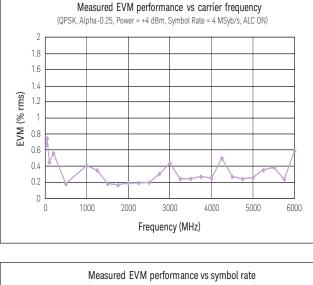
Performance evaluated at bottom, middle, and top of bands shown. WLAN 802.11ac 80 MHz, 256 QAM, MCS 8, 7 symbols, no filtering. Channel corrections enabled. Rx equalizer training preamble only. 5.

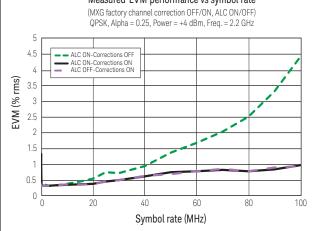






R s





Bit error rate [BER] analyzer (Option UN7)	
Clock rate	100 Hz to 60 MHz (usable to 90 MHz)
Data patterns	PN9, 11, 15, 20, 23
Resolution	10 digits
Bit sequence length	100 bits to 4,294 Gbits after synchronization
Other features	Input clock phase adjustment and gate delay
	Direct measurement triggering
	Data and reference signal outputs
	Real-time display
	Bit count
	Error-bit-count
	Bit error rate
	Pass/fail indication
	Valid data and clock detection
	Automatic re-synchronization
	Special pattern ignore

н

*

Frequency (MHz)

General Specifications

Remote programming					
nterfaces	GPIB IEEE-488.2, 1987 with listen an				
	LAN 1000BaseT LAN interface, LXI class C compliant USB Version 2.0				
Control languages	Control languages SCPI Version 1997.				
Compatibility languages	Keysight Technologies: N5181A\61A, N 5182A\62A, N5183A, E4438C, E4428C, E442xB, E443xB, E8241A, E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 Series, 8656B, E8663B, 8657A/B, 8662A, 8663A Aeroflex Incorporated: 3410 Series Rohde & Schwarz: SMB100A, SMBV100A, SMU200A, SMJ100A, SMATE200A, SMIQ, SML, SMV				
Power requirements					
00-120 VAC, 50/60/400 Hz					
20-240 VAC, 50/60 Hz					
60 W maximum (N5181B)					
300 W maximum (N5182B)					
Operating temperature range					
) to 55 °C					
Storage temperature range					
-40 to 70 °C					
)perating and storage altitude					
Jp to 15,000 feet					
Humidity					
Maximum Relative Humidity (non-condensing): 95%RH up to 40°C, decreases linearly t	to 45%RH at 55°C.1			
Environmental stress					
	d end-use; those stresses include but are	mental Test Manual and verified to be robust against the environ not limited to temperature, humidity, shock, vibration, altitude, milar to MIL-PRF-28800F Class 3			
Safety					
Complies with European Low Voltage Directiv	e 2006/95/EC				
– IEC/EN 61010-1, 2nd Edition	Acoustic noise emission	Geraeuschemission			
– Canada: CSA C22.2 No. 61010-1	LpA < 70 dB	LpA < 70 dB			
- USA: UL std no. 61010-1, 2nd Edition	Operator position	Am Arbeitsplatz			
 German Acoustic statement 	Normal position	Normaler Betrieb			
	Per ISO 7779	Nach DIN 45635 t.19			
Complies with European EMC Directive 2004	/108/EC				
 IEC/EN 61326-1or IEC/EN 61326-2-1 CISPR Pub 11 Group 1, class A AS/NZS CISPR 11 ICES/NMB-001 	This ISM device complies with Canadia cet appareil ISM est conforme a la nor				
Memory					
 Memory is shared by instrument states, 3 GB (30 GB with Option 009) memory a Security Option 006 allows storage of up 	vailable in the N5182B o to 8 GB on SD card				

- Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved

1. From 40 °C to 55 °C, the maximum % Relative Humidity follows the line of constant dew point.

Security (Option 006)

No internal non-volatile memory (Option SD0)

- Disable/remove any internal non-volatile memory or solid state drive
- User will not be able to store any files in the internal memory of the instrument
- Not compatible with instrument hardware option 009 (Internal Solid State Memory) and option 660 (Base Band Generator with Real-Time Capability)
- Requires firmware B.01.80 or newer

Self-test

Internal diagnostic routines test most modules in a preset condition; for each module, if its node voltages are within acceptable limits, the module passes the test

Weight

N5181B: \leq 13.6 kg (30 lb) net, \leq 28.6 kg (63 lb) shipping N5182B: \leq 15.9 kg (35 lb) net, \leq 30.8 kg (68 lb) shipping

Dimensions

88 mm H x 426 mm W x 489 mm L (length includes rear panel feet) (3.5 in H x 16.8 in W x 19.2 in L)

Max length (L) including RF connector tip to end of rear panel feet is 508 mm (20 in)

Recommended calibration cycle

36 months

ISO compliant

This instrument is manufactured in an ISO-9001 registered facility in concurrence with Keysight Technologies' commitment to quality.

Inputs and Outputs

Front panel connectors				
RF output	Outputs the RF signal via a precision N type female connector; see output section for reverse power protection information			
I and Q inputs	BNC input accepts "in-phase" and "quadrature" input signals for I/Q modulation; nominal input impedance is 50 Ω , damage levels are 1 Vrms and 5 Vpeak			
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument; also used with U2000, U848X and U202X Series USB power sensors.			
Rear panel connectors				
Rear panel inputs and outputs are 3.3 V	CMOS, unless indicated otherwise; CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL voltage levels			
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector			
I and Q inputs (Option 1EM)	Accepts "in-phase" and "quadrature" input signals for I/Q modulation SMB connector, nominal input impedance is 50 Ω ; damage levels are 1 Vrms and 5 Vpeak; Option 1EM units will come with 2 SMB to BNC adapters			
I and Q outputs	BNC outputs the analog I/Q modulation signals from the internal baseband generator; nominal output impedance 50 Ω , DC coupled; damage levels ± 2 V			
I bar and Q bar outputs (Option 1EL)	BNC outputs the complement of the I and Q signals for differential applications;			
Event 1	This connector outputs the programmable timing signal generated by marker 1 The marker signal can also be routed internally to control the RF blanking and ALC hold functions; this signal is also available on the AUX I/O connector With bit error rate analyzer (Option UN7) this connector is used for data input Damage levels are > +8 V and < -4 V			

Pattern trigger	Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband generators Accepts CMOS signal with minimum pulse width of 10 ns Female BNC Damage levels are > +8 V and < -4 V
BBTRIG 1	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for clock input
BBTRIG 2	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for gate input
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping; this output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode; output impedance < 1 Ω , can drive 2 k Ω ; damage levels are ± 15 V
Ext 1	External AM/FM/PM #1 input; nominal input impedance is 50 $\Omega/600~\Omega/1M~\Omega,~$ nominal; damage levels are ±5 V
Ext 2	External AM/FM/PM #2 input; nominal input impedance is 50 $\Omega/600~\Omega$ /1M $\Omega,~$ nominal; damage levels are \pm 5 V
LF OUT	0 to 5 V peak into 50 Ω, –5 V to 5 V offset, nominal
Pulse	External pulse modulation input; this input is TTL and CMOS compatible; low logic levels are 0 V and high logic levels are +1 V; nominal input impedance is 50 Ω ; input damage levels are ≤ -0.3 V and $\geq +5.3$ V
Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode; damage levels are \leq -0.3 V and \geq +5.3 V
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode, and low when dwell is over or point trigger is received This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video Nominal output impedance 50 Ω Input damage levels are ≤ -0.3 V and $\geq +5.3$ V
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase; Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz; nominal input level -3 to $+20$ dBm, impedance 50 Ω , sine or square waveform
10 MHz out	Outputs the 10 MHz reference signal used by internal timebase; level nominally +3.9 dBm; nominal output impedance 50 Ω ; input damage level is +16 dBm
LO in (Option 012)	Accepts a signal from a master signal generator that is used as the LO for MXG vector in order to configure a phase coherent system; nominal input levels between 0 to +12 dBm; nominal input impedance 50 Ω
LO out (Option 012)	Outputs a reference signal that can be used in a phase coherent system; nominal output levels between 0 to +12 dBm; nominal output impedance 50 Ω
DAC Clk In (Option 012)	Reserved for future use.
Digital bus I/O	To be used with PXB or N5102A digital signal interface module

Aux I/O	Aux I/O port sends and/or receives auxiliary signaling information: For Option UN7 this connector is used to output reference data, clock, error signals, and more Output markers to an external device from arbitrary waveform or real-time generation application such as: frame markers, pulse-per-second, even-second, and more. Input signals from external DUT to modify characteristics of a signal being generated such as changing output power (power control loop testing), advancing or delaying timing (timing advance loop testing), HARQ ACK/NAK delivery (HARQ process loop testing) or streaming external data, clock and symbol synch for custom modulation. I/O is application specific (CDMA, 3GPP, GNSS, LTE, custom). See User Guide or Signal Studio help for more details. Connector type: 36 pin 3M connector (part number N10236-52B2PC). The mating connector is a 3M 10136-3000 wire mount plug or 3M 10136-8000 IDC plug with a 3M 10336 shell. For Option 431 real-time custom modulation the follow pin numbers are assigned: Data input = pin 23 Data clock input = pin 29 Symbol sync input = pin 25 Burst input = pin 35 Data cock output = pin 35 Data clock output = pin 37 Event 1 output = pin 1
	Event 2 output = pin 33
USB 2.0	The USB connector provides remote programming functions via SCPI
LAN (1000 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector and is also used to access the internal Web server and FTP server Supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive LXI class C compliant Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical; delayed/alarm triger is unknown Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical
GPIB	The GPIB connector provides remote programming functionality via SCPI

Related Literature

Keysight X-Series Signal Generators

MXG Configuration Guide	5990-9959EN
EXG Data Sheet	5991-0039EN
EXG Configuration Guide	5990-9958EN
X-Series Signal Generator Brochure	5990-9957EN
Signal Studio Software Brochure	5989-6448EN
N5182BX07 User Guide	N5182-90001

Learn more at: www.keysight.com

For more information on Keysight Technologies' products, applications or services, please contact your local Keysight office. The complete list is available at: www.keysight.com/find/contactus

